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Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	16
Program Memory Size	3.5KB (2K x 14)
Program Memory Type	FLASH
EEPROM Size	256 x 8
RAM Size	256 x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 3.6V
Data Converters	A/D 12x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	20-SSOP (0.209", 5.30mm Width)
Supplier Device Package	20-SSOP
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TABLE 1: 18/20/28-PIN SUMMARY (PIC16(L)F1826/27)

I/O	18-Pin PDIP/SOIC	20-Pin SSOP	28-Pin QFN/UQFN	ANSEL	A/D	Reference	Cap Sense	Comparator	SR Latch	Timers	CCP	EUSART	MSSP	Interrupt	Modulator	Pull-up	Basic
RA0	17	19	23	Y	AN0	—	CPS0	C12IN0-	—	—	—	—	SDO2(2)	—	—	N	—
RA1	18	20	24	Y	AN1	—	CPS1	C12IN1-	—	—	—	—	$\overline{\text{SS2}}$(2)	—	—	N	—
RA2	1	1	26	Y	AN2	VREF- DACOUT	CPS2	C12IN2- C12IN+	—	—	—	—	—	—	—	N	—
RA3	2	2	27	Y	AN3	VREF+	CPS3	C12IN3- C1IN+ C1OUT	SRQ	—	CCP3(2)	—	—	—	—	N	—
RA4	3	3	28	Y	AN4	—	CPS4	C2OUT	SRNQ	T0CKI	CCP4(2)	—	—	—	—	N	—
RA5	4	4	1	N	—	—	—	—	—	—	—	—	$\overline{\text{SS1}}$(1)	—	—	Y(3)	$\overline{\text{MCLR}}$, VPP
RA6	15	17	20	N	—	—	—	—	—	—	P1D(1) P2B(1,2)	—	SDO1(1)	—	—	N	OSC2 CLKOUT CLKR
RA7	16	18	21	N	—	—	—	—	—	—	P1C(1) CCP2(1,2) P2A(1,2)	—	—	—	—	N	OSC1 CLKIN
RB0	6	7	7	N	—	—	—	—	SRI	T1G	CCP1(1) P1A(1) FLT0	—	—	INT IOC	—	Y	—
RB1	7	8	8	Y	AN11	—	CPS11	—	—	—	—	RX(1,4) DT(1,4)	SDA1 SDI1	IOC	—	Y	—
RB2	8	9	9	Y	AN10	—	CPS10	—	—	—	—	RX(1),DT(1) TX(1,4) CK(1,4)	SDA2(2) SDI2(2) SDO1(1,4)	IOC	MDMIN	Y	—
RB3	9	10	10	Y	AN9	—	CPS9	—	—	—	CCP1(1,4) P1A(1,4)	—	—	IOC	MDOUT	Y	—
RB4	10	11	12	Y	AN8	—	CPS8	—	—	—	—	—	SCL1 SCK1	IOC	MDCIN2	Y	—
RB5	11	12	13	Y	AN7	—	CPS7	—	—	—	P1B	TX(1) CK(1)	SCL2(2) SCK2(2) $\overline{\text{SS1}}$(1,4)	IOC	—	Y	—
RB6	12	13	15	Y	AN5	—	CPS5	—	—	T1CKI T1OSI	P1C(1,4) CCP2(1,2,4) P2A(1,2,4)	—	—	IOC	—	Y	ICSPCLK/ ICDCLK
RB7	13	14	16	Y	AN6	—	CPS6	—	—	T1OSO	P1D(1,4) P2B(1,2,4)	—	—	IOC	MDCIN1	Y	ICSPDAT/ ICDDAT
VDD	14	15,16	17,19	—	—	—	—	—	—	—	—	—	—	—	—	—	VDD
Vss	5	5,6	3,5	—	—	—	—	—	—	—	—	—	—	—	—	—	Vss

Note 1: Pin functions can be moved using the APFCON0 or APFCON1 register.
2: Functions are only available on the PIC16(L)F1827.
3: Weak pull-up always enabled when $\overline{\text{MCLR}}$ is enabled, otherwise the pull-up is under user control.
4: Default function location.

TABLE 3-3: PIC16(L)F1826/27 MEMORY MAP (CONTINUED)

Bank	Address	Contents	Address	Contents	Address	Contents
BANK16	800h – 80Bh	Core Registers (Table 3-2)	80Ch – 86Fh	Unimplemented Read as '0'	870h – 87Fh	Common RAM (Accesses 70h – 7Fh)
BANK17	880h – 88Bh	Core Registers (Table 3-2)	88Ch – 8EFh	Unimplemented Read as '0'	8F0h – 8FFh	Common RAM (Accesses 70h – 7Fh)
BANK18	900h – 90Bh	Core Registers (Table 3-2)	90Ch – 96Fh	Unimplemented Read as '0'	970h – 97Fh	Common RAM (Accesses 70h – 7Fh)
BANK19	980h – 98Bh	Core Registers (Table 3-2)	98Ch – 9EFh	Unimplemented Read as '0'	9F0h – 9FFh	Common RAM (Accesses 70h – 7Fh)
BANK20	A00h – A0Bh	Core Registers (Table 3-2)	A0Ch – A6Fh	Unimplemented Read as '0'	A70h – A7Fh	Common RAM (Accesses 70h – 7Fh)
BANK21	A80h – A8Bh	Core Registers (Table 3-2)	A8Ch – AEFh	Unimplemented Read as '0'	AF0h – AFFh	Common RAM (Accesses 70h – 7Fh)
BANK22	B00h – B0Bh	Core Registers (Table 3-2)	B0Ch – B6Fh	Unimplemented Read as '0'	B70h – B7Fh	Common RAM (Accesses 70h – 7Fh)
BANK23	B80h – B8Bh	Core Registers (Table 3-2)	B8Ch – BEFh	Unimplemented Read as '0'	BF0h – BFFh	Common RAM (Accesses 70h – 7Fh)

Bank	Address	Contents	Address	Contents	Address	Contents
BANK 24	C00h – C0Bh	Core Registers (Table 3-2)	C0Ch – C6Fh	Unimplemented Read as '0'	C70h – C7Fh	Accesses 70h – 7Fh
BANK 25	C80h – C8Bh	Core Registers (Table 3-2)	C8Ch – CEFh	Unimplemented Read as '0'	CF0h – CFFh	Accesses 70h – 7Fh
BANK 26	D00h – D0Bh	Core Registers (Table 3-2)	D0Ch – D6Fh	Unimplemented Read as '0'	D70h – D7Fh	Accesses 70h – 7Fh
BANK 27	D80h – D8Bh	Core Registers (Table 3-2)	D8Ch – DEFh	Unimplemented Read as '0'	DF0h – DFFh	Accesses 70h – 7Fh
BANK 28	E00h – E0Bh	Core Registers (Table 3-2)	E0Ch – E6Fh	Unimplemented Read as '0'	E70h – E7Fh	Accesses 70h – 7Fh
BANK 29	E80h – E8Bh	Core Registers (Table 3-2)	E8Ch – EEFh	Unimplemented Read as '0'	EF0h – EFFh	Accesses 70h – 7Fh
BANK 30	F00h – F0Bh	Core Registers (Table 3-2)	F0Ch – F6Fh	Unimplemented Read as '0'	F70h – F7Fh	Common RAM (Accesses 70h – 7Fh)
BANK 31	F80h – F8Bh	Core Registers (Table 3-2)	F8Ch – F9Fh FA0h – FEFh	Unimplemented Read as '0' See Table 3-4 for more information	FF0h – FFFh	Common RAM (Accesses 70h – 7Fh)

Legend: (shaded) = Unimplemented data memory locations, read as '0'

TABLE 3-6: SPECIAL FUNCTION REGISTER SUMMARY (CONTINUED)

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Value on all other Resets
Bank 8											
40Ch	—	Unimplemented								—	—
40Dh	—	Unimplemented								—	—
40Eh	—	Unimplemented								—	—
40Fh	—	Unimplemented								—	—
410h	—	Unimplemented								—	—
411h	—	Unimplemented								—	—
412h	—	Unimplemented								—	—
413h	—	Unimplemented								—	—
414h	—	Unimplemented								—	—
415h	TMR4(1)	Timer4 Module Register								0000 0000	0000 0000
416h	PR4(1)	Timer4 Period Register								1111 1111	1111 1111
417h	T4CON(1)	—	T4OUTPS3	T4OUTPS2	T4OUTPS1	T4OUTPS0	TMR4ON	T4CKPS1	T4CKPS0	-000 0000	-000 0000
418h	—	Unimplemented								—	—
419h	—	Unimplemented								—	—
41Ah	—	Unimplemented								—	—
41Bh	—	Unimplemented								—	—
41Ch	TMR6(1)	Timer6 Module Register								0000 0000	0000 0000
41Dh	PR6(1)	Timer6 Period Register								1111 1111	1111 1111
41Eh	T6CON(1)	—	T6OUTPS3	T6OUTPS2	T6OUTPS1	T6OUTPS0	TMR6ON	T6CKPS1	T6CKPS0	-000 0000	-000 0000
41Fh	—	Unimplemented								—	—

Legend: x = unknown, u = unchanged, q = value depends on condition, - = unimplemented, r = reserved. Shaded locations are unimplemented, read as ‘0’.

Note 1: PIC16(L)F1827 only.

REGISTER 4-3: DEVICEID: DEVICE ID REGISTER(1)

R	R	R	R	R	R
DEV<8:3>					
bit 13					bit 8

R	R	R	R	R	R	R	R
DEV<2:0>			REV<4:0>				
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘1’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	P = Programmable bit

bit 13-5 **DEV<8:0>:** Device ID bits

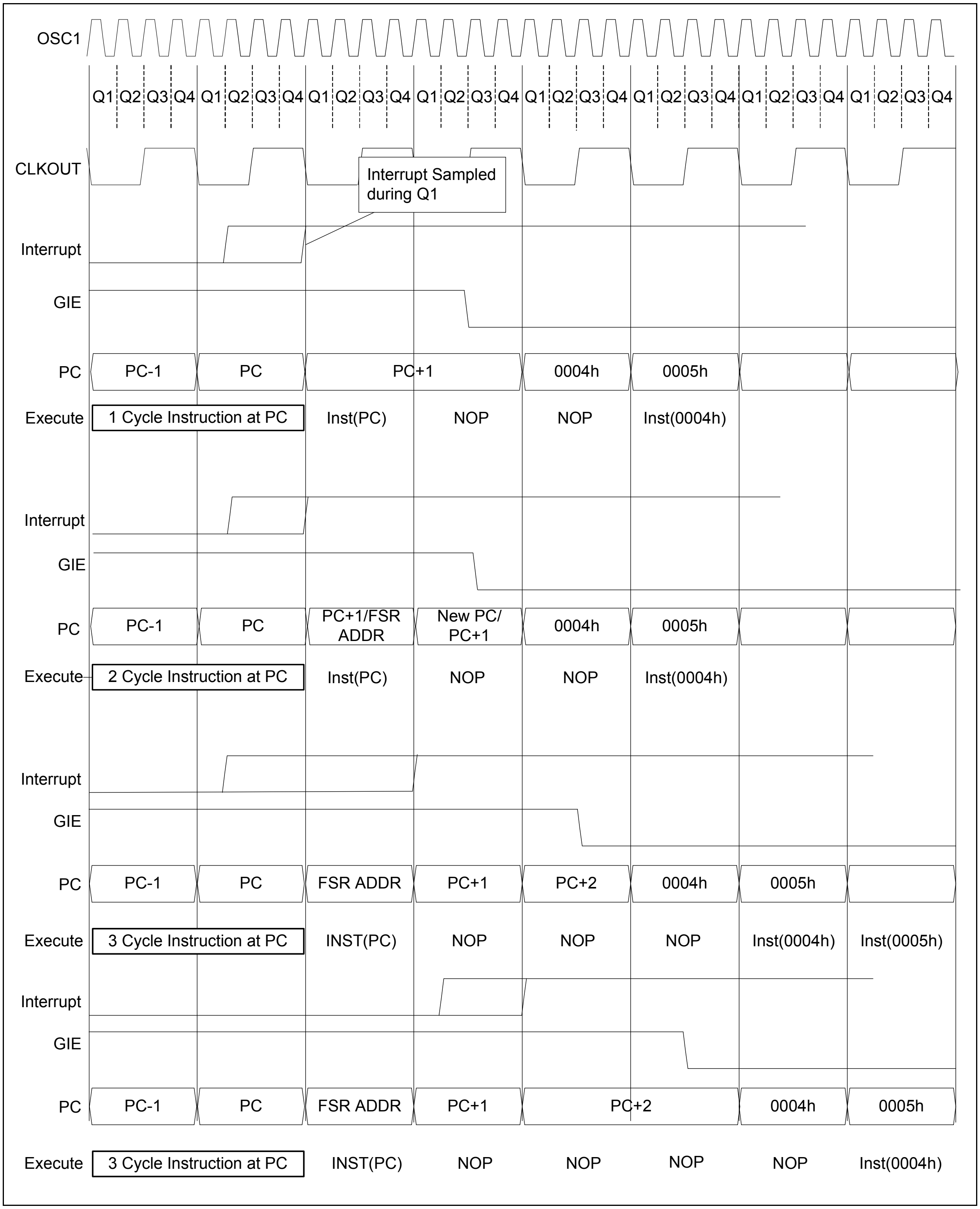
Device	DEVICEID<13:0> Values	
	DEV<8:0>	**REV<4:0>**
PIC16F1826	`10 0111 100`	`x xxxx`
PIC16F1827	`10 0111 101`	`x xxxx`
PIC16LF1826	`10 1000 100`	`x xxxx`
PIC16LF1827	`10 1000 101`	`x xxxx`

bit 4-0 **REV<4:0>:** Revision ID bits

These bits are used to identify the revision.

Note 1: This location cannot be written.

FIGURE 8-2: INTERRUPT LATENCY



12.2.3 PORTA FUNCTIONS AND OUTPUT PRIORITIES

Each PORTA pin is multiplexed with other functions. The pins, their combined functions and their output priorities are shown in Table 12-2.

When multiple outputs are enabled, the actual pin control goes to the peripheral with the highest priority.

Analog input functions, such as ADC, comparator and CapSense inputs, are not shown in the priority lists. These inputs are active when the I/O pin is set for Analog mode using the ANSELx registers. Digital output functions may control the pin when it is in Analog mode with the priority shown in Table 12-2.

TABLE 12-2: PORTA OUTPUT PRIORITY

Pin Name	Function Priority(1)
RA0	SDO2 (PIC16(L)F1827 only) RA0
RA1	$\overline{SS2}$ (PIC16(L)F1827 only) RA1
RA2	DACOUT (DAC) RA2
RA3	SRQ (SR latch) CCP3 (PIC16(L)F1827 only) C1OUT (Comparator) RA3
RA4	SRNQ (SR latch) CCP4 (PIC16(L)F1827 only) T0CKI C2OUT (Comparator) RA4
RA5	Input only pin
RA6	OSC2 (enabled by Configuration Word) CLKOUT CLKR SDO1 P1D P2B (PIC16(L)F1827 only) RA6
RA7	OSC1/CLKIN (enabled by Configuration Word) P1C CCP2 (PIC16(L)F1827 only) P2A (PIC16(L)F1827 only) RA7

Note 1: Priority listed from highest to lowest.

Each PORTA pin is multiplexed with other functions. The pins, their combined functions and their output priorities are briefly described here. For additional information, refer to the appropriate section in this data sheet.

When multiple outputs are enabled, the actual pin control goes to the peripheral with the lowest number in the following lists.

12.3.4 PORTB FUNCTIONS AND OUTPUT PRIORITIES

Each PORTB pin is multiplexed with other functions. The pins, their combined functions and their output priorities are shown in Table 12-5.

When multiple outputs are enabled, the actual pin control goes to the peripheral with the highest priority.

Analog input and some digital input functions are not included in the list below. These input functions can remain active when the pin is configured as an output. Certain digital input functions, such as the EUSART RX signal, override other port functions and are included in the priority list.

TABLE 12-5: PORTB OUTPUT PRIORITY

Pin Name	Function Priority(1)
RB0	P1A RB0
RB1	SDA1 RX/DT RB1
RB2	SDA2 (PIC16(L)F1827 only) TX/CK RX/DT SDO1 RB2
RB3	MDOUT CCP1/P1A RB3
RB4	SCL1 SCK1 RB4
RB5	SCL2 (PIC16(L)F1827 only) TX/CK SCK2 (PIC16(L)F1827 only) P1B RB5
RB6	ICSPCLK (Programming) T1OSI P1C CCP2 (PIC16(L)F1827 only) P2A (PIC16(L)F1827 only) RB6
RB7	ICSPDAT (Programming) T1OSO P1D P2B (PIC16(L)F1827 only) RB7

Note 1: Priority listed from highest to lowest.

14.3 FVR Control Registers

REGISTER 14-1: FVRCON: FIXED VOLTAGE REFERENCE CONTROL REGISTER

R/W-0/0	R-q/q	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
FVREN	FVRRDY[(1)]	Reserved	Reserved	CDAFVR<1:0>		ADFVR<1:0>	
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	q = Value depends on condition

bit 7 **FVREN:** Fixed Voltage Reference Enable bit
0 = Fixed Voltage Reference is disabled
1 = Fixed Voltage Reference is enabled

bit 6 **FVRRDY:** Fixed Voltage Reference Ready Flag bit[(1)]
0 = Fixed Voltage Reference output is not ready or not enabled
1 = Fixed Voltage Reference output is ready for use

bit 5-4 **Reserved:** Read as ‘0’. Maintain these bits clear.

bit 3-2 **CDAFVR<1:0>:** Comparator and DAC Fixed Voltage Reference Selection bit
00 = Comparator and DAC Fixed Voltage Reference Peripheral output is off.
01 = Comparator and DAC Fixed Voltage Reference Peripheral output is 1x (1.024V)
10 = Comparator and DAC Fixed Voltage Reference Peripheral output is 2x (2.048V)[(2)]
11 = Comparator and DAC Fixed Voltage Reference Peripheral output is 4x (4.096V)[(2)]

bit 1-0 **ADFVR<1:0>:** ADC Fixed Voltage Reference Selection bit
00 = ADC Fixed Voltage Reference Peripheral output is off.
01 = ADC Fixed Voltage Reference Peripheral output is 1x (1.024V)
10 = ADC Fixed Voltage Reference Peripheral output is 2x (2.048V)[(2)]
11 = ADC Fixed Voltage Reference Peripheral output is 4x (4.096V)[(2)]

Note 1: FVRRDY is always ‘1’ on devices with LDO (PIC16F1826/27).
2: Fixed Voltage Reference output cannot exceed V_{DD}.

TABLE 14-1: SUMMARY OF REGISTERS ASSOCIATED WITH THE FVR MODULE

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on page
FVRCON	FVREN	FVRRDY	Reserved	Reserved	CDAFVR1	CDAFVR0	ADFVR1	ADFVR0	136

Legend: Shaded cells are unused by the FVR module.

REGISTER 19-1: CMxCON0: COMPARATOR Cx CONTROL REGISTER 0

R/W-0/0	R-0/0	R/W-0/0	R/W-0/0	U-0	R/W-1/1	R/W-0/0	R/W-0/0
CxON	CxOUT	CxOE	CxPOL	—	CxSP	CxHYS	CxSYNC
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7 **CxON:** Comparator Enable bit
1 = Comparator is enabled and consumes no active power
0 = Comparator is disabled

bit 6 **CxOUT:** Comparator Output bit
If CxPOL = 1 (inverted polarity):
1 = CxVP < CxVN
0 = CxVP > CxVN
If CxPOL = 0 (non-inverted polarity):
1 = CxVP > CxVN
0 = CxVP < CxVN

bit 5 **CxOE:** Comparator Output Enable bit
1 = CxOUT is present on the CxOUT pin. Requires that the associated TRIS bit be cleared to actually drive the pin. Not affected by CxON.
0 = CxOUT is internal only

bit 4 **CxPOL:** Comparator Output Polarity Select bit
1 = Comparator output is inverted
0 = Comparator output is not inverted

bit 3 **Unimplemented:** Read as '0'

bit 2 **CxSP:** Comparator Speed/Power Select bit
1 = Comparator operates in normal power, higher speed mode
0 = Comparator operates in low-power, low-speed mode

bit 1 **CxHYS:** Comparator Hysteresis Enable bit
1 = Comparator hysteresis enabled
0 = Comparator hysteresis disabled

bit 0 **CxSYNC:** Comparator Output Synchronous Mode bit
1 = Comparator output to Timer1 and I/O pin is synchronous to changes on Timer1 clock source. Output updated on the falling edge of Timer1 clock source.
0 = Comparator output to Timer1 and I/O pin is asynchronous.

NOTES:

24.3.2 SETUP FOR PWM OPERATION

The following steps should be taken when configuring the CCP module for standard PWM operation:

1. Disable the CCPx pin output driver by setting the associated TRIS bit.
2. Load the PRx register with the PWM period value.
3. Configure the CCP module for the PWM mode by loading the CCPxCON register with the appropriate values.
4. Load the CCPRxL register and the DCxBx bits of the CCPxCON register, with the PWM duty cycle value.
5. Configure and start Timer2/4/6:
   - Select the Timer2/4/6 resource to be used for PWM generation by setting the CxTSEL<1:0> bits in the CCPTMRS register.
   - Clear the TMRxIF interrupt flag bit of the PIRx register. See Note below.
   - Configure the TxCKPS bits of the TxCON register with the Timer prescale value.
   - Enable the Timer by setting the TMRxON bit of the TxCON register.
6. Enable PWM output pin:
   - Wait until the Timer overflows and the TMRxIF bit of the PIRx register is set. See Note below.
   - Enable the CCPx pin output driver by clearing the associated TRIS bit.

> **Note:** In order to send a complete duty cycle and period on the first PWM output, the above steps must be included in the setup sequence. If it is not critical to start with a complete PWM signal on the first output, then step 6 may be ignored.

24.3.3 TIMER2/4/6 TIMER RESOURCE

The PWM standard mode makes use of one of the 8-bit Timer2/4/6 timer resources to specify the PWM period.

Configuring the CxTSEL<1:0> bits in the CCPTMRS register selects which Timer2/4/6 timer is used.

24.3.4 PWM PERIOD

The PWM period is specified by the PRx register of Timer2/4/6. The PWM period can be calculated using the formula of Equation 24-1.

EQUATION 24-1: PWM PERIOD

$$PWM\ Period = [(PRx) + 1] \bullet 4 \bullet T_{OSC} \bullet (TMRx\ Prescale\ Value)$$

Note 1: $T_{OSC} = 1/F_{OSC}$

When TMRx is equal to PRx, the following three events occur on the next increment cycle:

- TMRx is cleared
- The CCPx pin is set. (Exception: If the PWM duty cycle = 0%, the pin will not be set.)
- The PWM duty cycle is latched from CCPRxL into CCPRxH.

> **Note:** The Timer postscaler (see **Section 22.1 "Timer2/4/6 Operation"**) is not used in the determination of the PWM frequency.

24.3.5 PWM DUTY CYCLE

The PWM duty cycle is specified by writing a 10-bit value to multiple registers: CCPRxL register and DCxB<1:0> bits of the CCPxCON register. The CCPRxL contains the eight MSbs and the DCxB<1:0> bits of the CCPxCON register contain the two LSbs. CCPRxL and DCxB<1:0> bits of the CCPxCON register can be written to at any time. The duty cycle value is not latched into CCPRxH until after the period completes (i.e., a match between PRx and TMRx registers occurs). While using the PWM, the CCPRxH register is read-only.

Equation 24-2 is used to calculate the PWM pulse width.

Equation 24-3 is used to calculate the PWM duty cycle ratio.

EQUATION 24-2: PULSE WIDTH

$$Pulse\ Width = (CCPRxL{:}CCPxCON<5:4>) \bullet T_{OSC} \bullet (TMRx\ Prescale\ Value)$$

EQUATION 24-3: DUTY CYCLE RATIO

$$Duty\ Cycle\ Ratio = \frac{(CCPRxL{:}CCPxCON<5:4>)}{4(PRx + 1)}$$

The CCPRxH register and a 2-bit internal latch are used to double buffer the PWM duty cycle. This double buffering is essential for glitchless PWM operation.

The 8-bit timer TMRx register is concatenated with either the 2-bit internal system clock (FOSC), or 2 bits of the prescaler, to create the 10-bit time base. The system clock is used if the Timer2/4/6 prescaler is set to 1:1.

When the 10-bit time base matches the CCPRxH and 2-bit latch, then the CCPx pin is cleared (see Figure 24-4).

24.3.7 OPERATION IN SLEEP MODE

In Sleep mode, the TMRx register will not increment and the state of the module will not change. If the CCPx pin is driving a value, it will continue to drive that value. When the device wakes up, TMRx will continue from its previous state.

24.3.8 CHANGES IN SYSTEM CLOCK FREQUENCY

The PWM frequency is derived from the system clock frequency. Any changes in the system clock frequency will result in changes to the PWM frequency. See **Section 5.0 "Oscillator Module (With Fail-Safe Clock Monitor)"** for additional details.

24.3.9 EFFECTS OF RESET

Any Reset will force all ports to Input mode and the CCP registers to their Reset states.

24.3.10 ALTERNATE PIN LOCATIONS

This module incorporates I/O pins that can be moved to other locations with the use of the alternate pin function registers, APFCON0 and APFCON1. To determine which pins can be moved and what their default locations are upon a reset, see **Section 12.1 "Alternate Pin Function"** for more information.

TABLE 24-8: SUMMARY OF REGISTERS ASSOCIATED WITH STANDARD PWM

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
APFCON0	RXDTSEL	SDO1SEL	SS1SEL	P2BSEL(2)	CCP2SEL(2)	P1DSEL	P1CSEL	CCP1SEL	119
CCPxCON	PxM1(1)	PxM0(1)	DCxB1	DCxB0	CCPxM3	CCPxM2	CCPxM1	CCPxM0	226
CCPxAS	CCPxASE	CCPxAS2	CCPxAS1	CCPxAS0	PSSxAC1	PSSxAC0	PSSxBD1	PSSxBD0	228
CCPTMRS	C4TSEL1	C4TSEL0	C3TSEL1	C3TSEL0	C2TSEL1	C2TSEL0	C1TSEL1	C1TSEL0	227
INTCON	GIE	PEIE	TMR0IE	INTE	IOCIE	TMR0IF	INTF	IOCIF	86
PR2	Timer2 Period Register								189*
PR4	Timer4 Module Period Register								189*
PR6	Timer6 Module Period Register								189*
PSTRxCON	—	—	—	STRxSYNC	STRxD	STRxC	STRxB	STRxA	230
PWMxCON	PxRSEN	PxDC6	PxDC5	PxDC4	PxDC3	PxDC2	PxDC1	PxDC0	229
T2CON	—	T2OUTPS3	T2OUTPS2	T2OUTPS1	T2OUTPS0	TMR2ON	T2CKPS1	T2CKPS0	191
T4CON	—	T4OUTPS3	T4OUTPS2	T4OUTPS1	T4OUTPS0	TMR4ON	T4CKPS1	T4CKPS0	191
T6CON	—	T6OUTPS3	T6OUTPS2	T6OUTPS1	T6OUTPS0	TMR6ON	T6CKPS1	T6CKPS0	191
TMR2	Holding Register for the 8-bit TMR2 Time Base								189*
TMR4	Holding Register for the 8-bit TMR4 Time Base(1)								189*
TMR6	Holding Register for the 8-bit TMR6 Time Base(1)								189*
TRISB	TRISB7	TRISB6	TRISB5	TRISB4	TRISB3	TRISB2	TRISB1	TRISB0	127

Legend: — = Unimplemented locations, read as '0'. Shaded cells are not used by the PWM.
* Page provides register information.

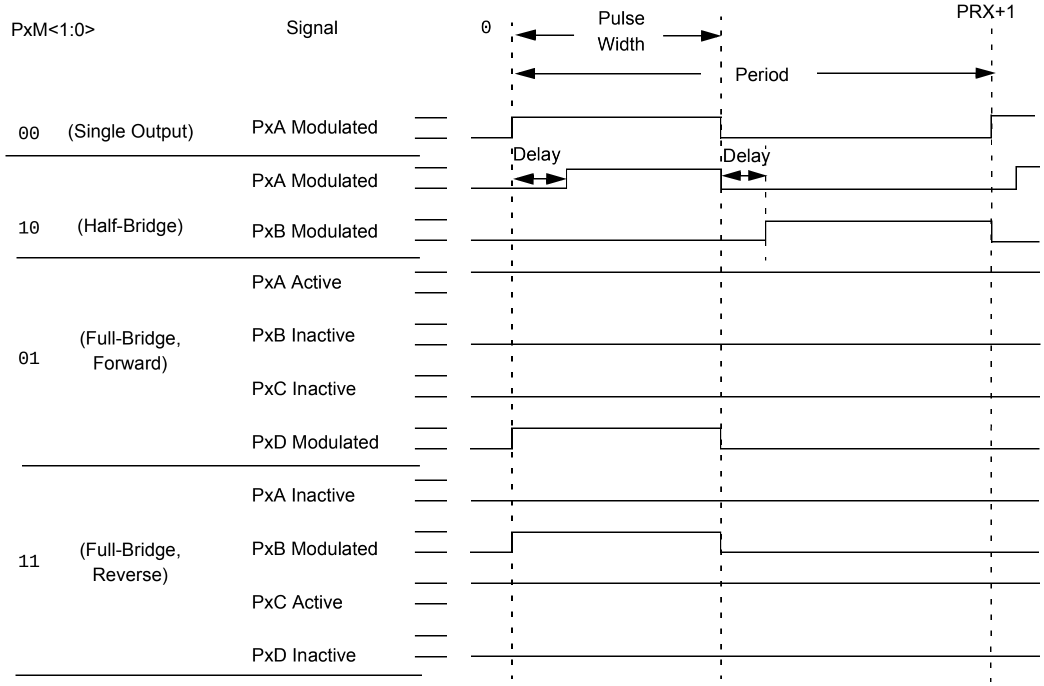
Note 1: Applies to ECCP modules only.
2: PIC16(L)F1827 only.

TABLE 24-9: EXAMPLE PIN ASSIGNMENTS FOR VARIOUS PWM ENHANCED MODES

ECCP Mode	PxM<1:0>	CCPx/PxA	PxB	PxC	PxD
Single	00	Yes(1)	Yes(1)	Yes(1)	Yes(1)
Half-Bridge	10	Yes	Yes	No	No
Full-Bridge, Forward	01	Yes	Yes	Yes	Yes
Full-Bridge, Reverse	11	Yes	Yes	Yes	Yes

Note 1: PWM Steering enables outputs in Single mode.

FIGURE 24-6: EXAMPLE PWM (ENHANCED MODE) OUTPUT RELATIONSHIPS (ACTIVE-HIGH STATE)



Relationships:
- Period = 4 * TOSC * (PRx + 1) * (TMRx Prescale Value)
- Pulse Width = TOSC * (CCPRxL<7:0>:CCPxCON<5:4>) * (TMRx Prescale Value)
- Delay = 4 * TOSC * (PWMxCON<6:0>)

24.5 CCP Control Registers

REGISTER 24-1: CCPxCON: CCPx CONTROL REGISTER

R/W-00	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
PxM<1:0>(1)		DCxB<1:0>		CCPxM<3:0>			
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Reset
‘1’ = Bit is set	‘0’ = Bit is cleared	

bit 7-6 **PxM<1:0>:** Enhanced PWM Output Configuration bits(1)

Capture mode:
Unused

Compare mode:
Unused

If CCPxM<3:2> = `00`, `01`, `10`:
`xx` = PxA assigned as Capture/Compare input; PxB, PxC, PxD assigned as port pins

If CCPxM<3:2> = `11`:
`00` = Single output; PxA modulated; PxB, PxC, PxD assigned as port pins
`01` = Full-Bridge output forward; PxD modulated; PxA active; PxB, PxC inactive
`10` = Half-Bridge output; PxA, PxB modulated with dead-band control; PxC, PxD assigned as port pins
`11` = Full-Bridge output reverse; PxB modulated; PxC active; PxA, PxD inactive

bit 5-4 **DCxB<1:0>:** PWM Duty Cycle Least Significant bits

Capture mode:
Unused

Compare mode:
Unused

PWM mode:
These bits are the two LSbs of the PWM duty cycle. The eight MSbs are found in CCPRxL.

bit 3-0 **CCPxM<3:0>:** ECCPx Mode Select bits

`0000` =Capture/Compare/PWM off (resets ECCPx module)
`0001` =Reserved
`0010` =Compare mode: toggle output on match
`0011` =Reserved

`0100` =Capture mode: every falling edge
`0101` =Capture mode: every rising edge
`0110` =Capture mode: every 4th rising edge
`0111` =Capture mode: every 16th rising edge

`1000` =Compare mode: initialize ECCPx pin low; set output on compare match (set CCPxIF)
`1001` =Compare mode: initialize ECCPx pin high; clear output on compare match (set CCPxIF)
`1010` =Compare mode: generate software interrupt only; ECCPx pin reverts to I/O state
`1011` =Compare mode: Special Event Trigger (ECCPx resets Timer, sets CCPxIF bit, starts A/D conversion if A/D module is enabled)(1)

CCP Modules only:
`11xx` =PWM mode

ECCP Modules only:
`1100` =PWM mode: PxA, PxC active-high; PxB, PxD active-high
`1101` =PWM mode: PxA, PxC active-high; PxB, PxD active-low
`1110` =PWM mode: PxA, PxC active-low; PxB, PxD active-high
`1111` =PWM mode: PxA, PxC active-low; PxB, PxD active-low

Note 1: These bits are not implemented on CCP<4:3>.

25.6.7 I²C MASTER MODE RECEPTION

Master mode reception is enabled by programming the Receive Enable bit, RCEN bit of the SSPxCON2 register.

Note:	The MSSPx module must be in an Idle state before the RCEN bit is set or the RCEN bit will be disregarded.

The Baud Rate Generator begins counting and on each rollover, the state of the SCLx pin changes (high-to-low/low-to-high) and data is shifted into the SSPxSR. After the falling edge of the eighth clock, the receive enable flag is automatically cleared, the contents of the SSPxSR are loaded into the SSPxBUF, the BF flag bit is set, the SSPxIF flag bit is set and the Baud Rate Generator is suspended from counting, holding SCLx low. The MSSPx is now in Idle state awaiting the next command. When the buffer is read by the CPU, the BF flag bit is automatically cleared. The user can then send an Acknowledge bit at the end of reception by setting the Acknowledge Sequence Enable, ACKEN bit of the SSPxCON2 register.

25.6.7.1 BF Status Flag

In receive operation, the BF bit is set when an address or data byte is loaded into SSPxBUF from SSPxSR. It is cleared when the SSPxBUF register is read.

25.6.7.2 SSPxOV Status Flag

In receive operation, the SSPxOV bit is set when 8 bits are received into the SSPxSR and the BF flag bit is already set from a previous reception.

25.6.7.3 WCOL Status Flag

If the user writes the SSPxBUF when a receive is already in progress (i.e., SSPxSR is still shifting in a data byte), the WCOL bit is set and the contents of the buffer are unchanged (the write does not occur).

25.6.7.4 Typical Receive Sequence:

1. The user generates a Start condition by setting the SEN bit of the SSPxCON2 register.
2. SSPxIF is set by hardware on completion of the Start.
3. SSPxIF is cleared by software.
4. User writes SSPxBUF with the slave address to transmit and the R/$\overline{\text{W}}$ bit set.
5. Address is shifted out the SDAx pin until all 8 bits are transmitted. Transmission begins as soon as SSPxBUF is written to.
6. The MSSPx module shifts in the $\overline{\text{ACK}}$ bit from the slave device and writes its value into the ACKSTAT bit of the SSPxCON2 register.
7. The MSSPx module generates an interrupt at the end of the ninth clock cycle by setting the SSPxIF bit.
8. User sets the RCEN bit of the SSPxCON2 register and the Master clocks in a byte from the slave.
9. After the 8th falling edge of SCLx, SSPxIF and BF are set.
10. Master clears SSPxIF and reads the received byte from SSPxUF, clears BF.
11. Master sets $\overline{\text{ACK}}$ value sent to slave in ACKDT bit of the SSPxCON2 register and initiates the $\overline{\text{ACK}}$ by setting the ACKEN bit.
12. Masters $\overline{\text{ACK}}$ is clocked out to the Slave and SSPxIF is set.
13. User clears SSPxIF.
14. Steps 8-13 are repeated for each received byte from the slave.
15. Master sends a not $\overline{\text{ACK}}$ or Stop to end communication.

REGISTER 26-3: BAUDCON: BAUD RATE CONTROL REGISTER

R-0/0	R-1/1	U-0	R/W-0/0	R/W-0/0	U-0	R/W-0/0	R/W-0/0
ABDOVF	RCIDL	—	SCKP	BRG16	—	WUE	ABDEN
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	

bit 7 **ABDOVF:** Auto-Baud Detect Overflow bit
Asynchronous mode:
1 = Auto-baud timer overflowed
0 = Auto-baud timer did not overflow
Synchronous mode:
Don’t care

bit 6 **RCIDL**: Receive Idle Flag bit
Asynchronous mode:
1 = Receiver is Idle
0 = Start bit has been received and the receiver is receiving
Synchronous mode:
Don’t care

bit 5 **Unimplemented:** Read as ‘0’

bit 4 **SCKP**: Synchronous Clock Polarity Select bit
Asynchronous mode:
1 = Transmit inverted data to the TX/CK pin
0 = Transmit non-inverted data to the TX/CK pin
Synchronous mode:
1 = Data is clocked on rising edge of the clock
0 = Data is clocked on falling edge of the clock

bit 3 **BRG16:** 16-bit Baud Rate Generator bit
1 = 16-bit Baud Rate Generator is used
0 = 8-bit Baud Rate Generator is used

bit 2 **Unimplemented:** Read as ‘0’

bit 1 **WUE:** Wake-up Enable bit
Asynchronous mode:
1 = Receiver is waiting for a falling edge. No character will be received, byte RCIF will be set. WUE will automatically clear after RCIF is set.
0 = Receiver is operating normally
Synchronous mode:
Don’t care

bit 0 **ABDEN**: Auto-Baud Detect Enable bit
Asynchronous mode:
1 = Auto-Baud Detect mode is enabled (clears when auto-baud is complete)
0 = Auto-Baud Detect mode is disabled
Synchronous mode:
Don’t care

28.2 Low-Voltage Programming Entry Mode

The Low-Voltage Programming Entry mode allows the PIC16(L)F1826/27 devices to be programmed using VDD only, without high voltage. When the LVP bit of Configuration Word 2 is set to '1', the low-voltage ICSP programming entry is enabled. To disable the Low-Voltage ICSP mode, the LVP bit must be programmed to '0'.

Entry into the Low-Voltage Programming Entry mode requires the following steps:

1. MCLR is brought to VIL.
2. A 32-bit key sequence is presented on ICSPDAT, while clocking ICSPCLK.

Once the key sequence is complete, MCLR must be held at VIL for as long as Program/Verify mode is to be maintained.

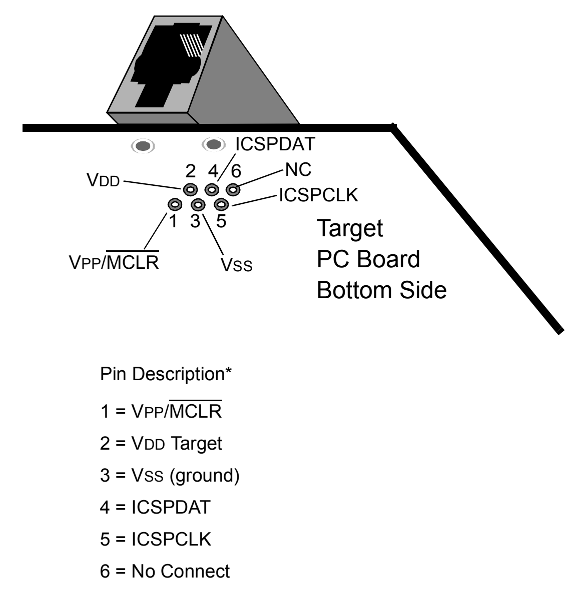
If low-voltage programming is enabled (LVP = 1), the MCLR Reset function is automatically enabled and cannot be disabled. See **Section 7.3 "MCLR"** for more information.

The LVP bit can only be reprogrammed to '0' by using the High-Voltage Programming mode.

28.3 Common Programming Interfaces

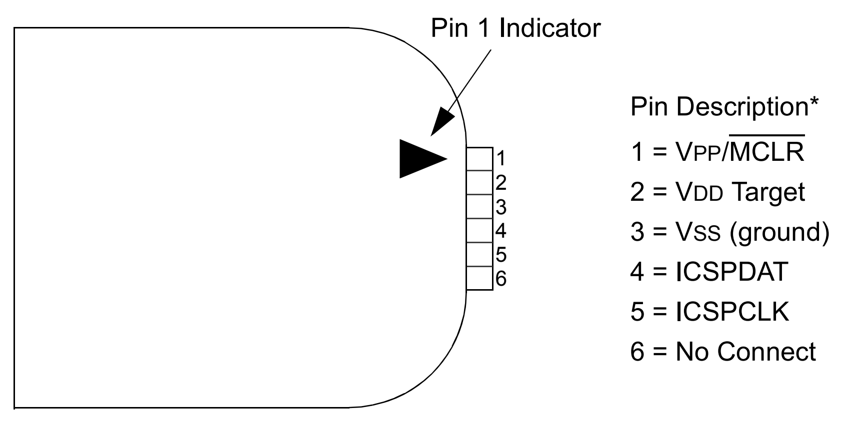
Connection to a target device is typically done through an ICSP™ header. A commonly found connector on development tools is the RJ-11 in the 6P6C (6 pin, 6 connector) configuration. See Figure 28-2.

FIGURE 28-2: ICD RJ-11 STYLE CONNECTOR INTERFACE



Another connector often found in use with the PICkit™ programmers is a standard 6-pin header with 0.1 inch spacing. Refer to Figure 28-3.

FIGURE 28-3: PICkit™ STYLE CONNECTOR INTERFACE



* The 6-pin header (0.100" spacing) accepts 0.025" square pins.

32.7 MPLAB SIM Software Simulator

The MPLAB SIM Software Simulator allows code development in a PC-hosted environment by simulating the PIC MCUs and dsPIC® DSCs on an instruction level. On any given instruction, the data areas can be examined or modified and stimuli can be applied from a comprehensive stimulus controller. Registers can be logged to files for further run-time analysis. The trace buffer and logic analyzer display extend the power of the simulator to record and track program execution, actions on I/O, most peripherals and internal registers.

The MPLAB SIM Software Simulator fully supports symbolic debugging using the MPLAB C Compilers, and the MPASM and MPLAB Assemblers. The software simulator offers the flexibility to develop and debug code outside of the hardware laboratory environment, making it an excellent, economical software development tool.

32.8 MPLAB REAL ICE In-Circuit Emulator System

MPLAB REAL ICE In-Circuit Emulator System is Microchip's next generation high-speed emulator for Microchip Flash DSC and MCU devices. It debugs and programs PIC® Flash MCUs and dsPIC® Flash DSCs with the easy-to-use, powerful graphical user interface of the MPLAB Integrated Development Environment (IDE), included with each kit.

The emulator is connected to the design engineer's PC using a high-speed USB 2.0 interface and is connected to the target with either a connector compatible with in-circuit debugger systems (RJ11) or with the new high-speed, noise tolerant, Low-Voltage Differential Signal (LVDS) interconnection (CAT5).

The emulator is field upgradable through future firmware downloads in MPLAB IDE. In upcoming releases of MPLAB IDE, new devices will be supported, and new features will be added. MPLAB REAL ICE offers significant advantages over competitive emulators including low-cost, full-speed emulation, run-time variable watches, trace analysis, complex breakpoints, a ruggedized probe interface and long (up to three meters) interconnection cables.

32.9 MPLAB ICD 3 In-Circuit Debugger System

MPLAB ICD 3 In-Circuit Debugger System is Microchip's most cost effective high-speed hardware debugger/programmer for Microchip Flash Digital Signal Controller (DSC) and microcontroller (MCU) devices. It debugs and programs PIC® Flash microcontrollers and dsPIC® DSCs with the powerful, yet easy-to-use graphical user interface of MPLAB Integrated Development Environment (IDE).

The MPLAB ICD 3 In-Circuit Debugger probe is connected to the design engineer's PC using a high-speed USB 2.0 interface and is connected to the target with a connector compatible with the MPLAB ICD 2 or MPLAB REAL ICE systems (RJ-11). MPLAB ICD 3 supports all MPLAB ICD 2 headers.

32.10 PICkit 3 In-Circuit Debugger/ Programmer and PICkit 3 Debug Express

The MPLAB PICkit 3 allows debugging and programming of PIC® and dsPIC® Flash microcontrollers at a most affordable price point using the powerful graphical user interface of the MPLAB Integrated Development Environment (IDE). The MPLAB PICkit 3 is connected to the design engineer's PC using a full speed USB interface and can be connected to the target via an Microchip debug (RJ-11) connector (compatible with MPLAB ICD 3 and MPLAB REAL ICE). The connector uses two device I/O pins and the reset line to implement in-circuit debugging and In-Circuit Serial Programming™.

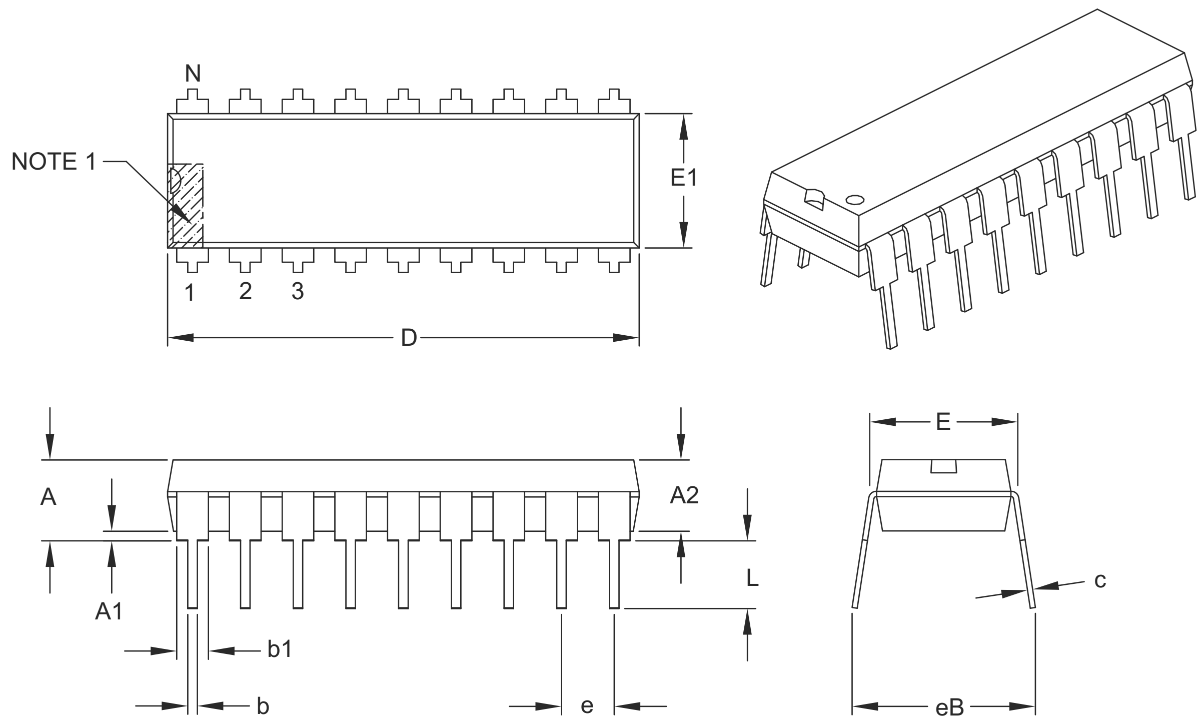
The PICkit 3 Debug Express include the PICkit 3, demo board and microcontroller, hookup cables and CDROM with user's guide, lessons, tutorial, compiler and MPLAB IDE software.

33.2 Package Details

The following sections give the technical details of the packages.

18-Lead Plastic Dual In-Line (P) – 300 mil Body [PDIP]

Note:	For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Units		INCHES		
Dimension Limits		MIN	NOM	MAX
Number of Pins	N	18		
Pitch	e	.100 BSC		
Top to Seating Plane	A	–	–	.210
Molded Package Thickness	A2	.115	.130	.195
Base to Seating Plane	A1	.015	–	–
Shoulder to Shoulder Width	E	.300	.310	.325
Molded Package Width	E1	.240	.250	.280
Overall Length	D	.880	.900	.920
Tip to Seating Plane	L	.115	.130	.150
Lead Thickness	c	.008	.010	.014
Upper Lead Width	b1	.045	.060	.070
Lower Lead Width	b	.014	.018	.022
Overall Row Spacing §	eB	–	–	.430

Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.
2. § Significant Characteristic.
3. Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" per side.
4. Dimensioning and tolerancing per ASME Y14.5M.

   BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing C04-007B